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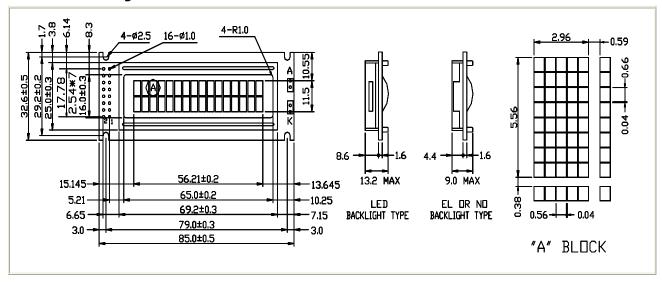
17. Function Test & Inspection Criteria

18. Character Generator ROM Map

### 1. General Specifications

ITEM	STA	ANDARD VALUE		UNIT			
Number of Characters	16 Ch	naracters x 2 Lines					
Character Format	ī						
Module Dimension	85.0 (W) x 32.6 (H) x 13.2 (T) mr						
LCD Polarizer	STN Transflective / Negative Blue / 6 o'clock						
Display Viewing Area	65.0 (W) x 16.0 (H)						
Display Active Area	56.21 (W) x 11.50 (H)						
Character Size	2.9	6 (W) x 5.56 (H)		mm			
Character Pitch	3.5	5 (W) x 5.94 (H)		mm			
Dot Size	0.5	6 (W) x 0.60 (H)		mm			
Dot Pitch	0.6	0 (W) x 0.70 (H)		mm			
LED Backlight Color	White						
LED Backlight Input	DC +3.3V	V	60	mA			
LED Backlight Life Time	10,000 HRS						

## 2. Mechanical Diagram



#### 3. Interface Pin Connections

# 4. Block Diagram

NO	SYMBOL	LEVEL	FUNCTION	
1	VSS		GND (0V)	
2	VDD	H/L	DC +5V	DB0 40 SEG
3	VO	H/L	Contrast Adjustment	DB7
4	R/S	H/L	Register Select	R/W LCD 16X2
5	R/w	H/L	Read/Write	LED TOAL
6	Е	H,H? L	Enable Signal	R/W LCD 16 X2  RS 40 SEG
7	DB0	H/L	Data Bit 0	
8	DB1	H/L	Data Bit 1	DRIVER IC
9	DB2	H/L	Data Bit 2	
10	DB3	H/L	Data Bit 3	
11	DB4	H/L	Data Bit 4	— → VDD
12	DB5	H/L	Data Bit 5	BACK VR VOICM
13	DB6	H/L	Data Bit 6	LIGHT
14	DB7	H/L	Data Bit 7	
15	A (+)	DC +5V	LED Backlight (+)	
16	K (-)	0V	LED Backlight (-)	
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### 5. Absolute Maximum Ratings

ITEM	SYMBOL	MIN	ТҮРЕ	MAX	UNIT			
Operating Temperature	ТОР	0		+50	°C			
Storage Temperature	TST	-10		+60	°C			
Input Voltage	VI	VSS		VDD	V			
Supply Voltage for Logic	VDD - VSS		5.0	6.5	V			
Supply Voltage for LCD	VDD - VO			6.5	V			
Static Electricity	Be sure that your are grounded when handling LCM							

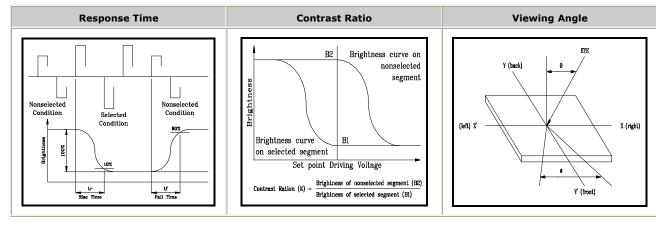
#### **6. Electrical Characteristics**

ITEM	SYMBOL	CONDITION	MIN	TYPE	MAX	UNIT
Supply Voltage for logic	VDD - VSS		4.5	5.0	5.5	V
Supply Voltage	VDD - VO	Ta = 0℃ Ta = 25℃ Ta = 50℃	  	4.8 4.4 4.1	  	V V V
Input High Voltage	VIH		2.2		VDD	V
Input Low Voltage	VIL		0		0.6	V
Output High Voltage	VOH		2.4			V
Output Low Voltage	VOL				0.4	V
Supply Current	IDD	VDD = +5V		3.0	4.5	mA

## 7. Optical Characteristics

ITEM	SYMBOL	CONDITION	MIN	TYPE	MAX	UNIT
Viewing Angle (V)	?	CR? 2	-10		40	deg
Viewing Angle (H)	f	CR? 2	-30		30	deg
Contrast Ratio	CR			5		
Response Time	TON			180	230	ms
Response Time	TOFF			100	150	ms

## 8. Optical Definitions



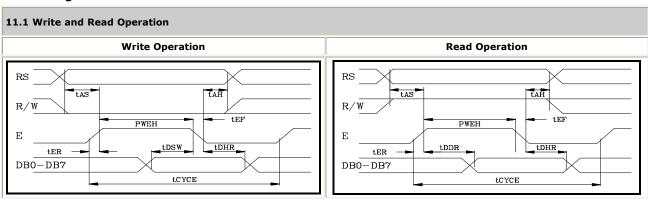
# 9. Display Address

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
LINE 1	80	81	82	83	84	85	86	87	88	89	8A	8B	8C	8D	8E	8F
LINE 2	C0	C1	C2	С3	C4	C5	C6	C7	C8	C9	CA	СВ	СС	CD	CE	CF
SSC2F	16DLN	W-E			UNI\	WORLI	D TEC	HNOL	OGY C	ORPC	RATIO	N		P	age:	3

#### 10. Interface to MPU

#### 10.2 Interface to MC6800 CPU 10.1 Interface to Z-80 CPU MVA AND MUX MC6800 /WR /RD LCM Z80 LCM NOR /IRQ NOR DO-D7 D0-D7 D0-D7 DO-D7 10.3 Interface to 4-bit CPU (HMCS43C) 10.4 Interface to HD6805 MP D15 HMCS43C HD6805 LCMLCMR10-R13 DB4-DB7 DB4-DB7

### 11. Timing Control



ITEM	SYMBOL	LIMIT (MIN)	LIMIT (MAX)	UNIT
Enable Cycle Time	tCYCE	1000		Ns
Enable Pulse Width (High Level)	PWEH	450		Ns
Enable Rise/Fall Time	tER, tEF		25	Ns
Address Set-Up Time (RS, R/W, E)	tAS	100		Ns
Address Hold Time	tAH	10		Ns
Data Set-Up Time	tDSW	100		Ns
Data Delay Time	tDDR		190	Ns
Data Hold Time	tDHR	20		ns

#### 11.2 Busy Flag Check Timing RS 8-bit busy flag check timing R/W $\mathbf{E}$ Internal Internal Operation No Bus DB7 Instruction Write Flag check Flag check Flag check Instruction Write RS 4-bit busy check timing

#### 12. Initialization of LCM

R/W E

DB7

Internal

The LCM automatically initializes ( reset ) when power is turned on using the internal reset circuit. If the power supply conditions for correctly operating of the internal reset circuit are not met, initialization by instruction is required. Use the procedure is next page for initialization.

ACS

No Busy

Flag check

D7

Instruction Write

DЗ

Internal Operation

Busy

# Vcc 0.2V 4.5V toff

(Note 1) 10 ms ? trcc ? 0.1 ms, toff ? 1 ms.

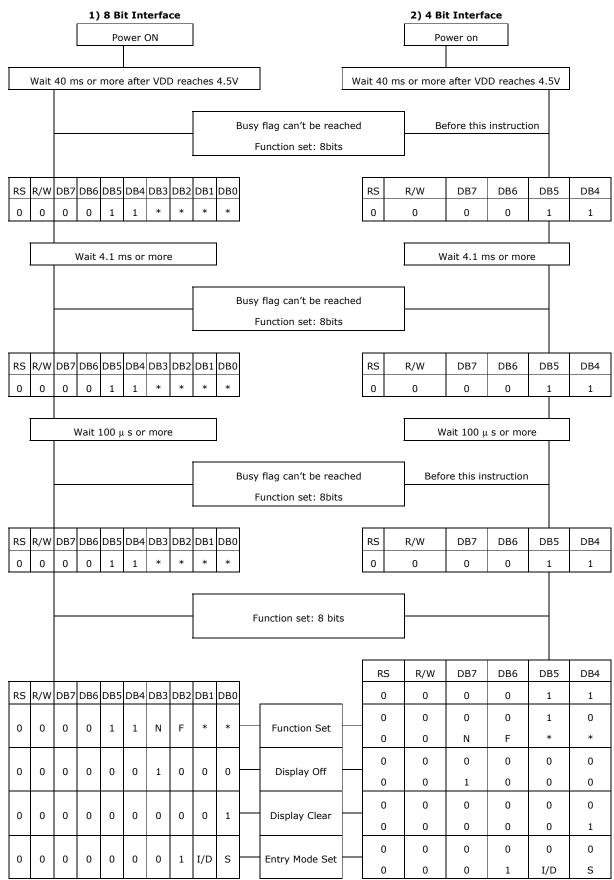
IR7

(IR3

Write

(Note 2) toff stipulates the time of power OFF for momentary power supply dip or when power supply cycles ON and OFF.

ITEM	SYMBOL	TEST COND.	LIMIT (MIN)	LIM (MAX)	UNIT	
Power Supply Rise Time	trcc		0.1	10	ms	
Power Supply Off Time	toff		1		ms	



• Busy flag is checked after instructions are completed. If busy flay isn't checked, the waiting time between instructions should be longer than execution time of these instructions.

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### 13. Instructions Set

FUNCTION	R	R/	DB	DB	DB	DB	DB	DB	DB	DB	DECCRIPTION	Execution Time
FUNCTION	s	w	7	6	5	4	3	2	1	0	DESCRIPTION	(max) (when fcp or fosc is 250 KHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Clears entire display and sets DD RAM address 0 in address counter	1.64 ms
Return Home	0	0	0	0	0	0	0	0	1	*	Sets DD RAM address 0 in address counter. Also returns display being shifted to original position. DD RAM contents remain unchanged	1.64 ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies shift of display. These operations are performed during data write and read.	<b>40</b> μ s
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	Set ON/OFF all display (D), cursor ON/OFF(C), and blink of cursor position character (B). D=1: ON display; 0:OFF display. C=1: ON cursor;0: OFF cursor. B=1: ON blink cursor; 0: OFF blink cursor.	<b>40</b> μ s
Cursor or Display Shift	0	0	0	0	0	1	S / C	R / L	x	x	Move the cursor and shift the display without changing DD RAM contents. S/C=1: Display shift; 0:Cursor move. R/L=1: shift to right; 0: shift to left.	40 μ s
Function Set	0	0	0	0	1	DL	N	F	x	x	Set the interface data length (DL). Number of display lines (N) and character font (F). DL=1: 8 bits; 0:4 bits. N=1: 2 lines; 0: 1 lines. F=1: 5x10 dots; 0: 5x7 dots.	40 μ s
Set CG RAM Address	0	0	0	1			ΑC	CG			Set CG RAM address. CG RAM data is sent and received after this setting.	40 μ s
Set DD RAM Address	0	0	1				ADD				Set DD RAM address. DD RAM data is sent and received after this setting	40 μ s
Read Busy Flag & Address	0	1	BF		AC					Reads Busy Flag (BF) indicating internal operation is being performed and reads address counter contents. BF=1: internally operating. 0: can accept instruction	1 µ s	
Write Data to CG/DDRAM	1	0			WRITE DATA					Write data into DD RAM or CG RAM.	40 μ s	
Read Data for CG/DDRAM	1	1			F	READ DATA		ТА			Read data from DD RAM or CG RAM	40 μ s

# 14. User Font Patterns (CD ROM Character)

Character Code (DD RAM data)	CG RAM Address	Character Pattern (CG RAM data)
Hi 76543210 Lo	5 4 3 2 1 0	Hi 765 4 3 2 1 0 Lo
	000	x x x 1 1 1 1 0
	0 0 1	x x x 1 0 0 0 1
	0 1 0	x x x 1 0 0 0 1
0000x000	000 011	x x x 1 1 1 1 0
	100	x x x 1 0 1 0 0
	1 0 1	x x x 1 0 0 1 0
	1 1 0	x x x 1 0 0 0 1
	111	x x x 0 0 0 0 0
	000	x x x 1 0 0 0 1
	0 0 1	x x x 0 1 0 1 0
	0 1 0	x x x 1 1 1 1 1
0000x001	001 011	x x x 0 0 1 0 0
	100	x x x 1 1 1 1 1
	1 0 1	x x x 0 0 1 1 0
	1 1 0	x x x 0 0 1 0 0
	111	x x x 0 0 0 0 0
	000	
	0 0 1	
	0 1 0	
0000x111	111 011	
	1 0 0	
	1 0 1	
	1 1 0	
	111	

# 15. Software Example

# 15.18-bit operation (8 bits 2 lines)

FUNCTION	R	R/ W	DB 7	DB 6	DB 5	DB 4	DB 3	DB 2	DB 1	DB 0	DISPLAY	DESCRIPTION		
Power on delay												Initialization. No display appears.		
Function set	0	0	0	0	1	1	0	0	x	x		Sets to 8-bit operation and selects 2-line display and 5x7 dots character font. ( Note: number of display lines and character fonts cannot be changed after this. )		
Display OFF	0	0	0	0	0	0	1	0	0	0		Turn off display.		
Display ON	0	0	0	0	0	0	1	1	1	0	_	Turn on display and cursor		
Entry Mode Set	0	0	0	0	0	0	0	1	1	0	-	Set mode to increment the address by one and to shift the cursor to the right, at the time of write, to the DD/CG RAM Display is not shifted.		
Write data to				1	0	1		0		_		Write "U". Cursor incremented by one and shift t		
CG/DD RAM	1	0	0	1	0	1	0	0	1	1	U_	right.		
Write data to	1	0	0	1	0	0	0	1	0	0				
CG/DD RAM	1	0	0	1	0	0	0	1	0	1	UTC_	Write "T" and "C".		
CO/DD ICAN	1	0	0	1	0	0	0	0	1	1				
C . DD DAM											UTC	Set RAM address so that the cursor is propositioned		
Set DD RAM	0	0	1	1	0	0	0	0	0	0	_	at the head of the second line.		
Write data to			*								UTC			
CG/DD RAM			*								TR_	Write "T", and "R".		
Cursor or display											UTC			
shift	0	0	0	0	0	1	0	0	Х	X	T <u>R</u>	Shift only the cursor position to the left.		
Write data to			*								итс	Write "ECH"		
CG/DD RAM			*								TECH_			
											итс	Set display mode shift at the time during writing		
Entry Mode Set	0	0	0	0	0	0	0	1	1	1	TECH_	operation.		
Write data to	4			4	4	1		_		_	итс	Write " x". Cursor incremented by one and shift to		
CG/DD RAM	1	0	0	1	1	1	1	0	0	0	TECH x_	right. (The display moves to left)		
Write data to			*									Write ather sharpetors		
CG/DD RAM			*								Write other characters.			
Return Home	0	0	0	0	0	0	0	0	1	0	<u>и</u> тс	Return both display and cursor to the original		
Return nome	J						U				TECH	position (Set address to zero).		

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# 15.2 4-bit operation ( 4-bit, 1 line )

FUNCTION	R S	R/ W	DB 7	DB 6	DB 5	DISPLAY	DESCRIPTION
Power on delay							Initialization. No display appears.
Function set	0	0	0	0	1	0	Sets to 4-bit operation. In this case, operation is handled as 8-bits by initialization, and only this instruction completes with one write.
Function set	0	0	0	0	1 x	0 x	Sets 4-bit operation and selects 1-line display and 5x7 dot character font on and resetting is needed. (Number of display lines and character fonts cannot be changed hence after).
Display ON/OFF Control	0 0	0 0	0 1	0 1	0	_	Turn on display and cursor.
Entry Mode Set	0	0	0	0	0	-	Set mode to incremented the address by one and to shift the cursor to the right, at the time of write. to the DD/CG RAM display is not shifted.
Write data to CG/DD RAM	1 1	0 0	0 0	1 0	0 1	S_	Write "S". Cursor incremented by one and shift to right.
					S	ame as 8-bit o	peration

## 16. Reliability Condition

			TN 1	ГҮРЕ	STN	ТҮРЕ	
			Normal Temp.	Wide Temp.	Normal Temp.	Wide Temp.	
Viewing			±30?	±30 °?	±30?	±30?	
Angle	Vertical T (?)	)	10? to 30?	10? to 30°?	-10? to 40?	-10? to 40?	
Operating 1	Temperature		-10? to 70?	-25? to 80?	0? to 50?	*-20? to 70?	
Storage Te	emperature		-20? to 80?	-35? to 90?	-20? to 70?	*-30? to 80?	
High Temperat	cure (Power Off)		240 Hours @70?	240 Hours @90?	240 Hours @65?	240 Hours @75?	
Low Temperat	ure (Power Off)		240 Hours @-20?	240 Hours @-35?	240 Hours @-15?	240 Hours @-25?	
High Temperat	cure (Power On)		240 Hours @70?	240 Hours @80?	240 Hours @60?	240 Hours @70?	
Low Temperat	ure (Power On)		240 Hours @-10?	240 Hours @-25?	240 Hours @-10?	240 Hours @-20?	
Illah Tamananah	a O III ala III aasidika		55? /90%RH	75? /90%RH	45? /90%RH	65? /90%RH	
High Temperatur	e & High Humidity		240 Hours	240 Hours	240 Hours	240 Hours	
Thermal Shock	С	Α	60min@-20?	60min@-35?	60min@-20?	60min@-30?	
5 Cycle —	В	В	5min@25?	5min@25?	5min@25?	5min@25?	
		С	60min@-70?	60min@90?	60min@70?	60min@80?	
Expec	ted Life		50,000 Hours	50,000 Hours	50,000 Hours	50,000 Hours	

<sup>\*</sup>Wide temperature version may not available for some products, Please consult our sales engineer or representative.

#### 17. Function Test & Inspection Criteria

#### 17.1 Sample plan

Sample plan according to MIL-STD-105D level 2, and acceptance/rejection criteria is.

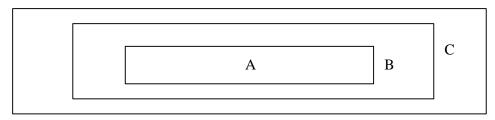
Base on: Major defect: AQL 0.65 Minor defect: AQL 2.5

#### 17.2 Inspection condition

Viewing distance for cosmetic inspection is 30cm with bare eyes, and under an environment of 800 lus (20W) light intensity.

All direction for inspecting the sample should be within 45°against perpendicular line.

#### 17.3 Definition of Inspection Zone in LCD



Zone A: Character / Digit area

Zone B : Viewing area except Zone A ( Zone A + Zone B = minimum Viewing area )

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of

customer's product.

### 17.4 Major Defect

All functional defects such as open ( or missing segment ), short, contrast differential, excess power consumption, smearing, leakage, etc. and overall outline dimension beyond the drawing. Are classified as major defects.

#### 17.5 Minor Defect

Except the Major defects above, all cosmetic defects are classified as minor defects.

NO.	Item to be Inspected		Inspection	Standard		Classification of defects		
		Zone size (mm	\	Acceptable				
		Zone size (min	A	A B				
	Spot defect	F ? 0.15		(clustering of t allowed)				
1	(Defects in spot from)	0.15? F ? 0.20	1	2	Acceptable	Minor		
		0.20? F ? 0.25	0	1				
		F >0.25	0	0				
		Remarks : for da	rk/white spot, siz	e F is define	d as F =1/2(X+)			
		Size (	mm)	Acce	ptable Qty			
		L	W		Zone			
			VV	А	ВС			
		Acceptable	W? 0.02	Acceptal	ole			
	Line defect (Defects in line form)	L? 3.0	W? 0.03	2				
2		L>2.5	W? 0.03	0	Acceptab	le Minor		
	(Bereets III line form)	L? 3.0	0.03 <w? 0.05<="" td=""><td>2</td><td></td><td></td></w?>	2				
		L>2.5	0.03 <w? 0.05<="" td=""><td>0</td><td></td><td></td></w?>	0				
			vs					
		Remarks: The tot four.						
3	Orientation defect (such as misalignment of L/C)	Not allowe	Minor					
		17.5.4.1 Polarize 1. Shifting in dimension. 2. Incomplete allowed.						
		17.5.4.2 Scratch	,					
				Acceptable	Qty			
4	Polarizing	Size (mm)		Zone		Minor		
			А	В	С			
		F ? 0.20	Acc	ceptable				
		0.20 <f 0.50<="" ?="" td=""><td>)</td><td>3</td><td></td><td></td></f>	)	3				
		0.50 <f 1.00<="" ?="" td=""><td>)</td><td>2</td><td>Acceptable</td><td>2</td></f>	)	2	Acceptable	2		
		F >1.00		0				

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## 18. Character Generator ROM Map

			CHA	RACT	ER P	ATTE	RN C	HAR1	(5X	7 DO	TS +	CUR	SOR)				
	Higher 4 bit			Upp	er 4-	bit ([	04 to	D7)	of Ch	arac	ter C	ode (	Hexa	deci	mal)		
Lowe	er 4 bit	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
	XXXX0000	CG RAM (1)						*•	<b>:</b> -					<b>:</b>			
	XXXX0001	(2)			1			-==	-==			<b></b>		<b>;</b>		-===	
	XXXX0010	(3)		##					<b>!</b> "			i"	4	ij	<b>;::</b>		
mal)	XXXX0011	(4)		#	3		===	<u>:</u>	:::.			<b>i</b>	<b>:</b>		<b>=</b>	<b>:::.</b>	<b>:::</b>
(Hexadecimal)	XXXX0100	(5)		#	4				╬			••		ŀ	•	<b> </b>	<u>::</u>
e (He)	XXXX0101	(6)			:			===	<b></b>			==	-	<b>;</b>		===	
er Code	XXXX0110	(7)						₽"	i.,.i							<b>:</b>	
of Character	XXXX0111	(8)						====						×			<b></b>
of CF	XXXX1000	(1)					X	<b>!</b>	×			ď	-::	_	<b>!</b> !	<b>.</b>	×
to D3)	XXXX1001	(2)		3		I	¥	1	•				•	į		:	<b>!</b>
it (Do	XXXX1010	(3)		*	#	<b>.</b>	<b></b>	<u>.j</u>	=					ľì	<u>.</u>	1	#
Lower 4-bit	XXXX1011	(4)			:	K		l:	•			<b>:</b>	<b>#</b>			:-:	<b>;=</b>
Low	XXXX1100	(5)		:	4		Ħ	1				#=	≣.;	<b></b> ;		<b>:</b>	
	XXXX1101	(6)						m	}				<b>.</b> =:	•••		<b>!</b>	
	XXXX1110	(7)		==			••••	<b>!</b> ":	-				##		•••		
	XXXX1111	(8)			:				<b>-</b>			• :::	<b>`.</b> .!	<b></b>			

CG RAM is character generator RAM having a character pattern storage function, which enables the user to change easily.